

Universal Serial Bus Peripheral Transceiver with Voltage Regulator

General Description

The USB1T1105A is an Universal Serial Bus Specification Rev 2.0 compliant transceiver. The device provides an USB interface for Full-Speed (12Mbit/s) USB applications. The USB1T1105A provides excellent flexibility, allowing differential and single ended inputs while an integrated voltage regulator sets the I/O level to 1.65V to 3.6V. Utilizing an integrated 5.0V to 3.3V voltage regulator, the part can be powered directly from the USB host (V_{BUS}) to minimize the power consumed from the local sources while used in devices with low supply voltages.

The USB1T1105A provides 15kV ESD protection on the USB bus pins (D+/D-). This eliminates the need for any external ESD devices while providing excellent protection to larger and more expensive ASICs and USB controllers.

Features

- Complies with Universal Serial Bus Specification 2.0
- Integrated 5V to 3.3V voltage regulator for powering VBus
- Utilizes digital inputs and outputs to transmit and receive USB cable data
- Supports full speed 12Mbits/s speed data rates
- Ideal for portable electronic devices
- 15kV contact HBM ESD protection on bus pins
- 3.3mm leadless package
- Industry standard HBCC footprint is lead-free

Applications

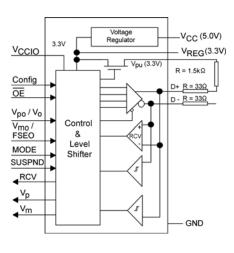
- Cell phone
- PDA
- Digital camera
- MP3

Ordering Code:

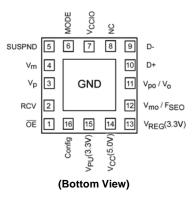
o	order Number	Package Number	Package Description
U	SB1T1105AMHX	MLP16HB	Pb-Free 16-Terminal Molded Leadless Package (MHBCC), JEDEC MO-217, 3mm Square

Pb-Free package per JEDEC J-STD-020B.

Logic Diagram



Connection Diagram



Terminal Descriptions

Terminal Number	Terminal Name	I/O	Terminal Description				
1	1 OE I		Output Enable: Active LOW enables the transceiver to transmit data on the bus. We not active the transceiver is in the receive mode (CMOS level is relative to V_{CCIO})				
2	RCV	0	Receive Data Output: Non-inverted CMOS level output for USB differential Input (CMOS output level is relative to V_{CCIO}). Driven LOW when SUSPN is HIGH; RCV output is stable and preserved during SE0 condition.				
3	V _p	0	Single-ended D+ receiver output V _P (CMOS level relative to V _{CCIO}): Used for external detection of SEO, error conditions, speed of connected device; Driven HIGH when no supply connected to V _{CC} and V _{REG} .				
4	V _m	0	Single-ended D- receiver output V _m (CMOS level relative to V _{CCIO}): Used for external detection of SEO, error conditions, speed of connected device; Driven HIGH when no supply connected to V _{CC} and V _{REG} .				
5	SUSPND	I	Suspend: Enables a low power state (CMOS level is relative to V_{CCIO}). While the SUSPND pin is active (HIGH) it will drive the RCV pin to logic "0" state.				
6 MODE I		I	MODE input (CMOS level is relative to V_{CCIO}). A HIGH selects the differential input MODE (V_{po} , V_{mo}) whereas a LOW enables the single-ended MODE (V_o , V_{FSEO}) see Table 2 and Table 3				
7	V _{CCIO}		Supply Voltage for digital I/O pins (1.65V to 3.6V): When not connected the D ₊ and D ₋ pins are in 3-STATE. This supply bus is totally independent of V _{CC} (5V) and V _{REG} (3.3V).				
8	NC	NC					
10, 9	D+, D-	AI/O	Data +, Data -: Differential data bus conforming to the USB standard.				
11	V _{po} / V _o	I	Driver Data Input (CMOS level is relative to V _{CCIO}); Schmitt trigger input; see Table 2 and Table 3				
12	V _{mo} / F _{SEO}	I	Driver Data Input (CMOS level is relative to V _{CCIO}); Schmitt trigger input; see Table 2 and Table 3				
13	V _{REG} (3.3V)		Internal Regulator Option: Regulated supply output voltage (3.0V to 3.6V) during 5V operation; decoupling capacitor of at least 0.1 μ F is required.				
14	V _{CC} (5.0V)		Internal Regulator Option: Used as supply voltage input (4.0V to 5.5V); can be connected directly to USB line Vbus.				

Terminal Number	Terminal Name	I/O	Terminal Description
15	V _{PU} (3.3V)		Pull-up Supply Voltage $(3.3V \pm 10\%)$: Connect an external $1.5k\Omega$ resistor on D+ (FS data rate); Pin function is controlled by Config input pin: Config = LOW - V _{PU} (3.3V) is floating (High Impedance) for zero pull-up current. Config = HIGH - V _{PU} (3.3V) = 3.3V; internally connected to V _{REG} (3.3V).
16	Config	Ι	USB connect or disconnect software control input. Configures 3.3V to external $1.5k\Omega$ resistor on D+ when HIGH.
Exposed Diepad	GND	GND	GND supply down bonded to exposed diepad to be connected to the PCB GND.

Functional Description

The USB1T1105A transceiver is designed to convert CMOS data into USB differential bus signal levels and to convert USB differential bus signal to CMOS data.

To minimize EMI and noise the outputs are edge rate controlled with the rise and fall times controlled and defined for full speed data rates. The rise, fall times are balanced between the differential pins to minimize skew. Table 1 describes the specific pin functionality selection. Table 2, Table 3, and Table 4 describe the specific Truth Tables for Driver and Receiver operating functions.

The USB1T1105A also has the capability of various power supply configurations to support mixed voltage supply applications (see Table 5) and Power Supply Configurations and Options for detailed descriptions.

Functional Tables

	TABLE 1. Function Select								
SUSPND	OE	D+, D-	RCV	V _p /V _m	Function				
L	L	Driving & Receiving	Active	Active	Normal Driving (Differential Receiver Active)				
L	Н	Receiving (Note 1)	Active	Active	Receiving				
Н	L	Driving	Inactive (Note 2)	Active	Driving during Suspend (Differential Receiver Inactive)				
Н	Н	3-STATE (Note 1)	Inactive (Note 2)	Active	Low Power State				

Note 1: Signal levels is function of connection and/or pull-up/pull-down resistors.

Note 2: For SUSPND = HIGH mode the differential receiver is inactive and the output RCV output is forced LOW. The out-of-suspend signaling (K) is detected via the singleended receiver outputs of the V_p and V_m pins.

TABLE 2. Driver Function ($\overline{OE} = L$) using Differential Input Interface Mode Pin = H

V _{mo}	V _{po}	Data
L	L	SE0 (Note 3)
L	Н	Differential Logic 1
Н	L	Differential Logic 0
Н	Н	Illegal State

Note 3: SE0 = Single Ended Zero

TABLE 3. Driver Function ($\overline{OE} = L$) using Single-ended Input Interface Mode Pin = L

FSE0	Vo	Data		
L	L	Differential Logic 0		
L H		Differential Logic 1		
Н	L	SE0 (Note 4)		
Н	Н	SE0 (Note 4)		

Note 4: SE0 = Single Ended Zero

TABLE 4. Receiver Function ($\overline{OE} = H$)

D+, D-	RCV	Vp	V _m
Differential Logic 1	н	Н	L
Differential Logic 0	L	L	Н
SE0	Х	L	L
Sharing Mode	L	Н	Н

X = Don't Care

Power Supply Configurations and Options

The three modes of power supply operation are:

- · Normal Mode: Regulated Output and Regulator Bypass
 - 1. Regulated Output: V_{CCIO} is connected and V_{CC} (5.0) is connected to 5V (4.0V to 5.5V) and the internal voltage regulator then produces 3.3V for the USB connections.
 - 2. Internal Regulator Bypass Mode: V_{CCIO} is connected and both $V_{CC}(5.5)$ and $V_{REG}(3.3)$ are connected to a 3.3V source (3.0V to 3.6V).

In both cases for normal mode the V_{CCIO} is an independent voltage source (1.65V to 3.6V) that is a function of the external circuit configuration.

- Sharing Mode: V_{CCIO} is only supply connected. V_{CC} and V_{REG} are not connected. In this mode the D+ and D– pins are

3-STATE and the USB1T1105A allows external signals up to 3.6V to share the D+ and D– bus lines. Internally the circuitry limits leakage from D+ and D– pins (maximum 10 $\mu A)$ and V_{CCIO} such that device is in low power (suspended) state. Terminals Vbusmon and RCV are forced LOW as an indication of this mode with Vbusmon being ignored during this state.

• Disable Mode: V_{CCIO} is not connected. V_{CC} is connected, or V_{CC} and V_{REG} are connected. 0V to 3.3V in this mode D+ and D- are 3-STATE and V_{PU} is HIGH Impedance (switch is turned off). The USB1T1105A allows external signals up to 3.6V to share the D+ and D- bus lines. Internally the circuitry limits leakage from D+ and D- terminals (maximum 10 μ A).

A summary of the Supply Configurations is described in Table 5.

	Power Supply Mode Configuration						
Pins	Sharing	Disable	Normal (Regulated Output)	Normal (Regulator Bypass)			
V _{CC} (5V)	< 3.6V	Connected to 5V Source	Connected to 5V Source	Connected to V _{REG} (3.3V) [max drop of 0.3V] (2.7V to 3.6V)			
V _{REG} (3.3V)	Pulled LOW Regulator OFF	3.3V, 300 μA Regulated Output	3.3V, 300 μA Regulated Output	Connected to 3.3V Source			
V _{CCIO}	1.65V to 3.6V Source	Not Connected	1.65V to 3.6V Source	1.65V to 3.6V Source			
V _{PU} (3.3V)	3-STATE (Off)	3-STATE (Off)	3.3V Available if Config = HIGH	3.3V Available if Config = HIGH			
D+, D-	3-STATE	3-STATE	Function of Mode Set Up	Function of Mode Set Up			
V _p , V _m	Н	Invalid	Function of Mode Set Up	Function of Mode Set Up			
RCV	L	Invalid	Function of Mode Set Up	Function of Mode Set Up			
OE, SUSPND, Config, V _{po} /V _o , V _{mo} /F _{SEO} , MODE	Hi-Z	Hi-Z	Function of Mode Set Up				

TABLE 5. Power Supply Configuration Options

Note 5: Hi-Z or forced LOW.

USB1T1105A

Absolute Maximum Ratings(Note 6)

Supply Voltage (V _{CC})(5V)	-0.5V to +6.0V
I/O Supply Voltage (V _{CCIO})	-0.5V to +4.6V
Latch-up Current (I _{LU})	
$V_{I} = -1.8V$ to +5.4V	150 mA
DC Input Current (I _{IK})	
$V_{I} < 0$	–18 mA
DC Input Voltage (V _I)	
(Note 7)	-0.5V to V _{CCIO} +0.5V
DC Output Diode Current (I _{OK})	
$V_{O} > V_{CC} \text{ or } V_{O} < 0$	±18 mA
DC Output Voltage (V _O)	
(Note 7)	$-0.5V$ to V_{CCIO} $^+$ 0.5V
Output Source or Sink Current (I _O)	
$V_{O} = 0$ to V_{CC}	
Current for D+, D- Pins	±12 mA
Current for RCV, V _m /V _p	±12 mA
DC V _{CC} or GND Current	
(I _{CC} , I _{GND})	±100 mA
ESD Immunity Voltage (V _{ESD});	
Contact HBM	
Pins D+, D–, and GND	15kV
All Other Pins	2.5kV
Storage Temperature (T _{STO})	$-40^{\circ}C$ to $+$ 125°C
Power Dissipation (P _{TOT})	
I _{CC} (5V)	48 mW
I _{CCIO}	9 mW

Recommended Operating Conditions

DC Supply Voltage V_{CC} (5V)	4.0V to 5.5V
I/O DC Voltage V _{CCIO}	1.65V to 3.6V
DC Input Voltage Range (VI)	0V to V_{CCIO} + 0.5V
DC Input Range for AI/O (V _{IA/O})	0V to 3.6V
Pins D+ and D-	0V to 3.6V
Operating Ambient Temperature	
(T _{AMB})	$-40^{\circ}C$ to $+85^{\circ}C$

Note 6: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristic tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 7: IO Absolute Maximum Rating must be observed.

DC Electrical Characteristics (Supply Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). V_{CC} (5V) = 4.0V to 5.5V or V_{REG} (3.3V) = 3.0V to 3.6V, V_{CCIO} = 1.65V to 3.6V

				Units			
Symbol	Parameter	Conditions					
			Min	Min Typ Max			
V _{REG} (3.3V)	Regulated Supply Output	Internal Regulator Option;	3.0	3.3	3.6	v	
		$I_{LOAD} \leq 300 \ \mu A$	(Note 8)(Note 9)			v	
I _{CC}	Operating Supply Current (V _{CC} 5.0)	Transmitting and Receiving at		4.0	8.0	0	
		12 Mbits/s; C_{LOAD} = 50 pF (D+, D-)		(Note 10)		mA	
I _{CCIO}	I/O Operating Supply Current	Transmitting and Receiving at		1.0	2.0	0	
		12 Mbits/s		(Note 10)		mA	
I _{CC (IDLE)}	Supply Current during	IDLE: $V_{D+} \geq 2.7 V, \ V_{D-} \leq 0.3 V;$			500	•	
	FS IDLE and SE0 (V _{CC} 5.0)	SE0: $V_{D+} \leq$ 0.3V, $V_{D-} \leq 0.3V$			(Note 11)	μA	
ICCIO (STATIC)	I/O Static Supply Current	IDLE, SUSPND or SE0			20.0	μA	
ICC(SUSPND)	Suspend Supply Current	SUSPND = HIGH			25.0		
	USB1T1105A	OE = HIGH			(Note 11)	μA	
		$V_m = V_p = OPEN$					
ICCIO(SHARING)	I/O Sharing Mode Supply Current	V _{CC} (5V) Not Connected			20.0	μA	

DC Electrical Characteristics (Continued)

	Parameter	Conditions		Units		
Symbol			−40°C to +85°C			
			Min	Тур	Max	
I _{D±(SHARING)}	Sharing Mode Load Current on	V _{CC} (5V) Not Connected			10.0	
	D+/D- Pins	Config = LOW; $V_{D\pm}$ = 3.6V			10.0	μA
V _{CCTH}	V _{CC} Threshold Detection Voltage	$1.65V \leq V_{CCIO} \leq 3.6V$				
		Supply Lost			3.6	V
		Supply Present	4.1			
V _{CCHYS}	V _{CC} Threshold Detection	V _{CCIO} = 1.8V		70.0		
	Hysteresis Voltage			70.0		mV
V _{CCIOTH}	V _{CCIO} Threshold Detection Voltage	$2.7V \leq V_{REG} \leq 3.6V$				
		Supply Lost			0.5	V
		Supply Present	1.4			
V _{CCIOHYS}	V _{CCIO} Threshold Detection	V _{REG} = 3.3V		450		
	Hysteresis Voltage			450		mV

Note 8: I_{LOAD} includes the pull-up resistor current via pin V_{PU}

Note 9: The minimum voltage in Suspend mode is 2.7V.

Note 10: Not tested in production, value based on characterization.

Note 11: Excludes any current from load and V_{PU} current to the 1.5k Ω resistor.

Note 12: Includes current between V_{pu} and the 1.5k internal pull-up resistor.

Note 13: When V_{CCIO} < 2.7V, minimum value for V_{REGTH} = 2.0V for supply present condition.

DC Electrical Characteristics (Digital Pins – excludes D+, D- Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). V_{CCIO} = 1.6V to 3.6V

Symbol			Limits		
	Parameter	Test Conditions	-40°C	–40°C to +85°C	
			Min	Max	
Input Levels	·	·	·		
V _{IL}	LOW Level Input Voltage			0.3	V
V _{IH}	HIGH Level Input Voltage		0.6*V _{CCIO}		V
V _{HYS}	Hysteresis Voltage P11 + P12	Pins V_{po}/V_{mo} , $V_{CCIO} = 3.3V$	0.3	0.7	V
Output Levels			·		
V _{OL}	LOW Level Output Voltage	I _{OL} = 2 mA		0.4	V
		I _{OL} = 100 μA		0.15	
V _{OH}	HIGH Level Output Voltage	I _{OH} = 2 mA	V _{CCIO} - 0.4		V
		I _{OH} = 100 μA	V _{CCIO} - 0.15		
Leakage Curre	nt		·		
ILI	Input Leakage Current	V _{CCIO} = 1.65V to 3.6V		±1.0 (Note 14)	μA
Capacitance	·	·	·		
C _{IN} , C _{I/O}	Input Capacitance	Pin to GND		10.0	pF

Note 14: If $V_{CCIO} \geq V_{REG}$ then leakage current will be higher than specified.

DC Electrical Characteristics (Analog I/O Pins – D+, D– Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). V_{CC} = 4.0V to 5.5V or V_{REG} = 3.0V to 3.6V

				Limits		
Symbol	Parameter	Test Condition		-40°C to +85°C		
			Min	Тур	Max	
Input Levels – D	ifferential Receiver	·				•
V _{DI}	Differential Input Sensitivity	V _{I(D+)} - V _{I(D-)}	0.2			V
V _{CM}	Differential Common Mode Voltage		0.8		2.5	V
Input Levels – S	ingle-ended Receiver	·				•
V _{IL}	LOW Level Input Voltage				0.8	V
V _{IH}	HIGH Level Input Voltage		2.0			V
V _{HYS}	Hysteresis Voltage		0.4		0.7	V
Output Levels	·	·				•
V _{OL}	LOW Level Output Voltage	$R_L = 1.5 k\Omega$ to 3.6V			0.3	V
V _{OH}	HIGH Level Output Voltage	$R_L = 15k\Omega$ to GND	2.8 (Note 15)		3.6	V
Leakage Curren	t	·				
I _{LZ}	Input Leakage Current Off State	OE = H			±1.0	μA
Capacitance	·	·				•
C _{I/O}	I/O Capacitance	Pin to GND			20.0	pF
Resistance	·	·				•
Z _{DRV}	Driver Output Impedance		34.0	41.0 (Note 16)	44.0	Ω
Z _{IN}	Driver Input Impedance		10.0			MΩ
R _{SW}	Switch Resistance				10.0	Ω
V _{TERM}	Termination Voltage	R _{PU} Upstream Port	3.0 (Note 17) (Note 18)		3.6	v

Note 15: V_{OH} min. = V_{REG} - 0.2V.

Note 16: Includes external resistors of 33Ω on both D+ and D– pins.

Note 17: This voltage is available at pin V_{PU} and $V_{\text{REG}}.$

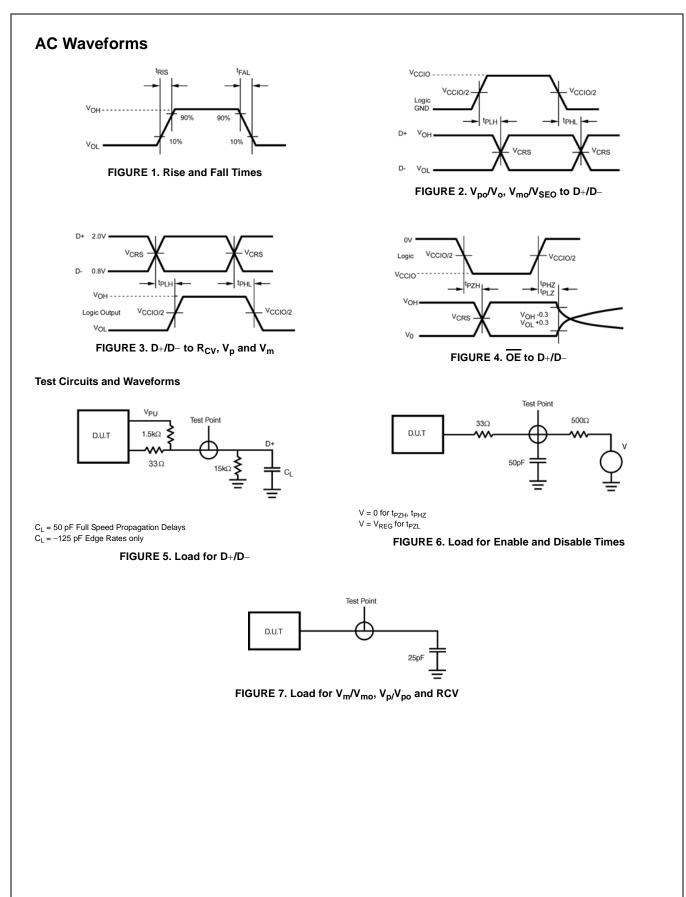
Note 18: Minimum voltage is 2.7V in the suspend mode.

AC Electrical Characteristics (A I/O Pins Full Speed)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). V_{CC} = 4.0V to 5.5V or V_{REG} = 3.0V to 3.6V, V_{CCIO} = 1.65V to 3.6V, C_L = 50 pF; R_L = 1.5K on D+ to V_{PU}

			Limits		Unit		
Symbol	Parameter	Test Conditions	−40°C to +85°C				
			Min Typ		Max	1	
Driver Characte	eristics						
t _{FR}	Output Rise Time	C _L = 50 – 125 pF	4.0		20.0		
		10% to 90%				ns	
t _{FF}	Output Fall Time	Figures 1, 5	4.0		20.0		
f _{RFM}	Rise/Fall Time Match	t _F / t _R Excludes First Transition	00.0			0/	
		90.0 from Idle State		90.0 111.1		%	
V _{CRS}	Output Signal Crossover Voltage	Excludes First Transition from				V	
(Note 19)	Idle State see Waveform		1.3		2.0		
Driver Timing	·	·	·	•			
t _{PLH}	Propagation Delay	Firmer 0.5			40.0		
t _{PHL}	$(V_p/V_{po}, V_m/V_{mo} \text{ to } D_+/D)$	Figures 2, 5			18.0	ns	
t _{PHZ}	Driver Disable Delay	Firmer 1.0			45.0		
t _{PLZ}	(OE to D+/D-)	Figures 4, 6			15.0	ns	
t _{PZH}	Driver Enable Delay	Firmer 1.0			45.0		
t _{PZL}	(OE to D+/D-)	Figures 4, 6			15.0	ns	
Receiver Timing	9						
t _{PLH}	Propagation Delay (Diff)	Figure 2.7			15.0		
t _{PHL}	(D+/D- to Rev)	Figures 3, 7			15.0	ns	
t _{PLH}	Single Ended Receiver Propagation Delay	Firmer OFirmer 7			40.0		
t _{PHL}	(D+/D- to V _p / V _{po} , V _m /V _{mo})	Figures 3Figure 7			18.0	ns	

Note 19: Not production tested, guaranteed by characterization.

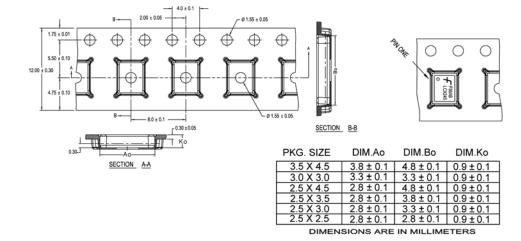


Tape and Reel Specification

Tape Format for MHBCC

Package	Таре	Number	Cavity	Cover Tape Status	
Designator	Section	Cavities	Status		
	Leader (Start End)	125 (typ)	Empty	Sealed	
MHX	Carrier	2500/3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)



NOTES: unless otherwise specified

1. Cummulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.

Smallest allowable bending radius.
Thru hole inside cavity is centered within cavity.

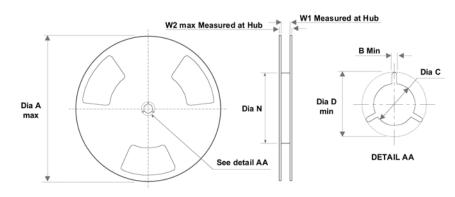
4. Tolerance is ±0.002[0.05] for these dimensions on all 12mm tapes.

5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.

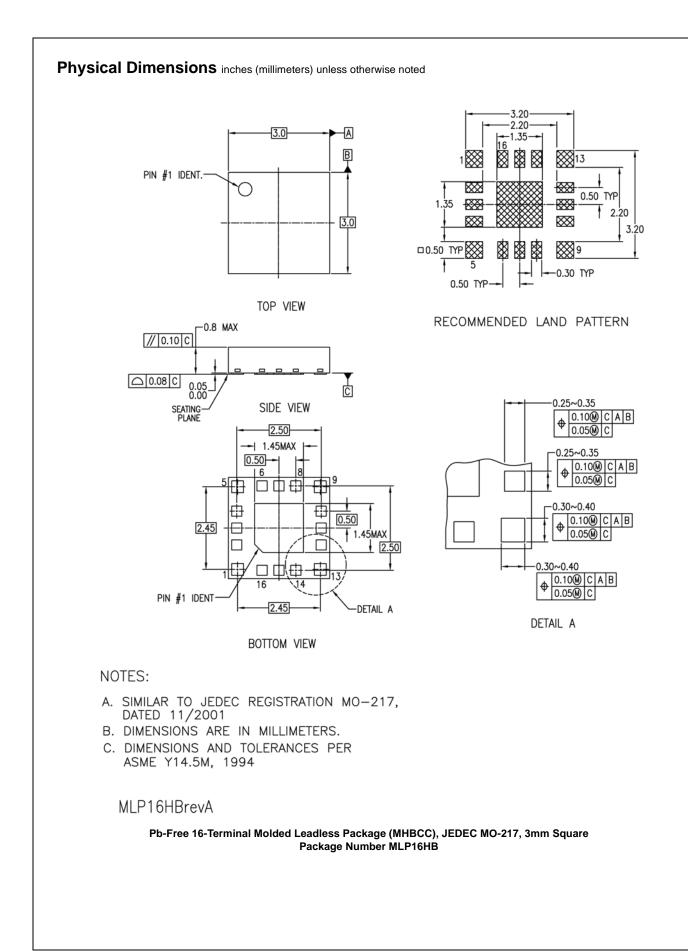
Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.

8. Controlling dimension is millimeter. Diemension in inches rounded.

REEL DIMENSIONS inches (millimeters)



Tape Size	Α	В	С	D	Ν	W1	W2
12 mm	13.0	0.059	0.512	0.795	7.008	0.488	0.724
12 11111	330	(1.50)	(13.00)	(20.20)	(178)	(12.4)	(18.4)



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provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of terms

Datasheet Identification	Product Status	Definition			
Advance Information	Formative or In Design	This datasheet contains the design specifications for product develop- ment. Specifications may change in any manner without notice.			
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No Identification Needed Full Production		This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.			
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